2N3634, 2N3634L, 2N3635, 2N3635L, 2N3636, 2N3636L, 2N3637, 2N3637L

Low Power Transistors

PNP Silicon

Features

- MIL-PRF-19500/357 Qualified
- Available as JAN, JANTX, JANTXV and JANHC

MAXIMUM RATINGS (T_A = 25° C unless otherwise noted)

Characteristic	Symbol	2N3634/L 2N3635/L	2N3636/L 2N3637/L	Unit		
Collector-Emitter Voltage	V _{CEO}	-140	-175	Vdc		
Collector-Base Voltage	V _{CBO}	-140	-175	Vdc		
Emitter-Base Voltage	V _{EBO}	-5.0		-5.0		Vdc
Collector Current – Continuous	Ι _C	1.0		Adc		
Total Device Dissipation @ $T_A = 25^{\circ}C$	PT	1.0		W		
Total Device Dissipation @ $T_C = 25^{\circ}C$	P _T	5.0		W		
Operating and Storage Junc- tion Temperature Range	T _J , T _{stg}	-65 to +200		°C		

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R_{\thetaJA}	175	°C/W
Thermal Resistance, Junction to Case	R_{\thetaJC}	35	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

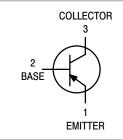
ORDERING INFORMATION

Level	Device	Package	Shipping	
	2N3634			
JAN JANTX JANTXV JANHC	2N3635	TO-39	Dulle	
	2N3636	10-39	Bulk	
	2N3637			
	2N3634L		Bulk	
	2N3635L	TO-5		
	2N3636L	10-5		
	2N3637L			



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TO-5 CASE 205AA STYLE 1 2N3634L 2N3635L 2N3636L 2N3637L



TO-39 CASE 205AB STYLE 1 2N3634 2N3635 2N3636 2N3637

2N3634, 2N3634L, 2N3635, 2N3635L, 2N3636, 2N3636L, 2N3637, 2N3637L

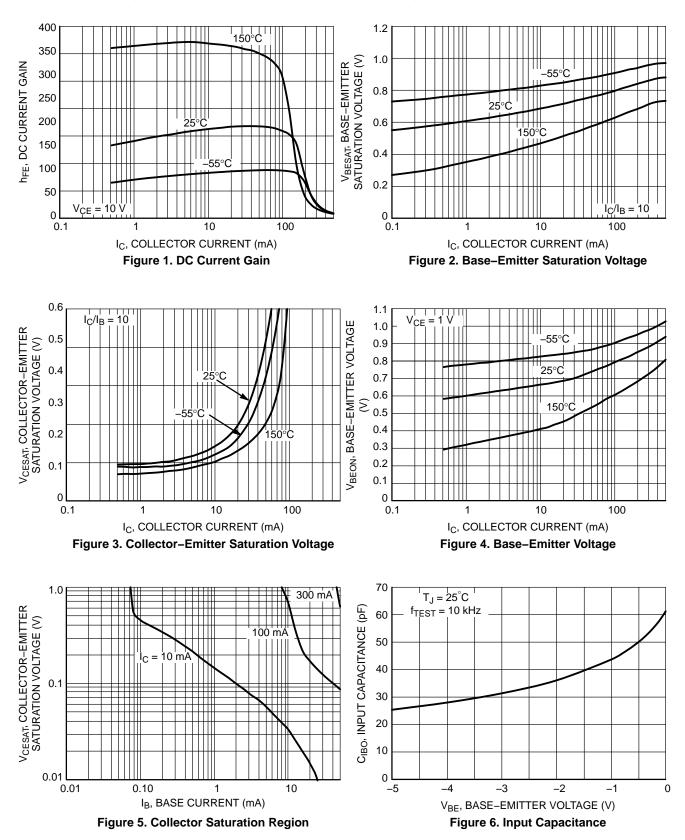
	ELECTRICAL CHARACTERISTICS (1	$T_A = 25^{\circ}C$ unless otherwise noted)
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Characteristic		Symbol	Min	Мах	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (I _C = –10 mA)	2N3634, 2N3635 2N3636, 2N3637	V _{(BR)CEO}	-140 -175		V
Emitter–Base Cutoff Current $(V_{EB} = -3.0 V)$ $(V_{EB} = -5.0 V)$		I _{EBO}		-50 -10	nA μA
Collector–Emitter Cutoff Current (V _{CE} = -100 V)		I _{CEO}	-	-10	μΑ
Collector–Base Cutoff Current $(V_{CB} = -100 \text{ V})$ $(V_{CB} = -140 \text{ V})$ $(V_{CB} = -175 \text{ V})$	2N3634, 2N3635 2N3636, 2N3637	I _{CBO}	- - -	-100 -10 -10	nA μA μA
ON CHARACTERISTICS (Note 1)					
DC Current Gain ($I_C = -0.1 \text{ mA}, V_{CE} = -10 \text{ V}$) ($I_C = -1.0 \text{ mA}, V_{CE} = -10 \text{ V}$) ($I_C = -10 \text{ mA}, V_{CE} = -10 \text{ V}$) ($I_C = -50 \text{ mA}, V_{CE} = -10 \text{ V}$) ($I_C = -150 \text{ mA}, V_{CE} = -10 \text{ V}$)	2N3634, 2N3636	h _{FE}	25 45 50 50 30	- - 150 -	-
DC Current Gain $(I_{C} = -0.1 \text{ mA}, V_{CE} = -10 \text{ V})$ $(I_{C} = -1.0 \text{ mA}, V_{CE} = -10 \text{ V})$ $(I_{C} = -10 \text{ mA}, V_{CE} = -10 \text{ V})$ $(I_{C} = -50 \text{ mA}, V_{CE} = -10 \text{ V})$ $(I_{C} = -150 \text{ mA}, V_{CE} = -10 \text{ V})$	2N3635, 2N3637	h _{FE}	55 90 100 100 60	- - 300 -	-
Collector – Emitter Saturation Voltage ($I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}$) ($I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$)		V _{CE(sat)}		-0.3 -0.6	V
Base – Emitter Saturation Voltage $(I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA})$ $(I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA})$		V _{BE(sat)}		-0.8 -0.9	V
SMALL-SIGNAL CHARACTERISTICS					I.
Magnitude of Small–Signal Current Gain (I _C = –30 mA, V _{CE} = –30 V, f = 100 MHz)	2N3634, 2N3636 2N3635, 2N3637	h _{fe}	1.5 2.0	8.0 8.5	-
Small–Signal Current Gain (I _C = -10 mA, V _{CE} = -10 V, f = 1 kHz)	2N3634, 2N3636 2N3635, 2N3637	h _{fe}	40 80	160 320	-
Output Capacitance (V_{CB} = -20 V, I_E = 0 A, 100 kHz \leq f \leq 1.0 MHz)		C _{obo}	-	10	pF
Input Capacitance (V _{EB} = -1.0 V, I _C = 0 A, 100 kHz \leq f \leq 1.0 MHz)		C _{ibo}	_	75	pF
Noise Figure $(V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ mA}, R_g = 1 \Omega, f = 100 \text{ Hz})$ $(V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ mA}, R_g = 1 \Omega, f = 1.0 \text{Hz})$ $(V_{CE} = -10 \text{ V}, I_C = -0.5 \text{mA}, R_g = 1 \Omega, f = 10 \text{Hz})$		NF	- - -	5.0 3.0 3.0	dB
SWITCHING CHARACTERISTICS					
Delay Time (Reference Figure 11 ir	MII – PRF–19500/357)	ta		100	ns

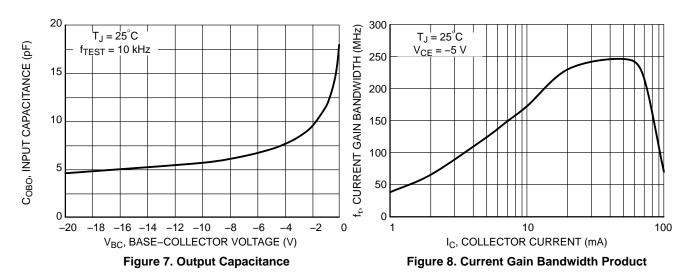
Delay Time	(Reference Figure 11 in MIL-PRF-19500/357) t _d		-	100	ns
Rise Time	ne (Reference Figure 11 in MIL-PRF-19500/357)		-	100	ns
Storage Time	(Reference Figure 11 in MIL-PRF-19500/357)	ts	-	500	ns
Fall Time	(Reference Figure 11 in MIL-PRF-19500/357)	t _f	-	150	ns
Turn–Off Time	(Reference Figure 11 in MIL-PRF-19500/357)	t _{off}	-	600	ns

1. Pulse Test: Pulse Width = 300 $\mu s,$ Duty Cycle \leq 2.0%.

2N3634, 2N3634L, 2N3635, 2N3635L, 2N3636, 2N3636L, 2N3637, 2N3637L

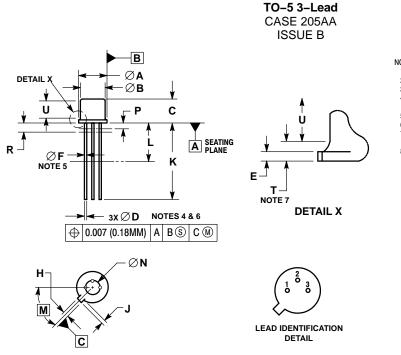


2N3634, 2N3634L, 2N3635, 2N3635L, 2N3636, 2N3636L, 2N3637, 2N3637L



2N3634, 2N3634L, 2N3635, 2N3635L, 2N3636, 2N3636L, 2N3637, 2N3637L

PACKAGE DIMENSIONS



NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCHES.

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 DIMENSION J MEASURED FROM DIAMETER A TO EDGE.
 LEAD TRUE POSITION TO BE DETERMINED AT THE GUAGE
 PLANE DEFINED BY DIMENSION R.
- DIMENSION F APPLIES BETWEEN DIMENSION P AND L. DIMENSION D APPLIES BETWEEN DIMENSION L AND K. 5.
- 6. 7. BODY CONTOUR OPTIONAL WITHIN ZONE DEFINED BY DIMEN-

SIONS A, B, AND T. 8. DIMENSION B SHALL NOT VARY MORE THAN 0.010 IN ZONE P.

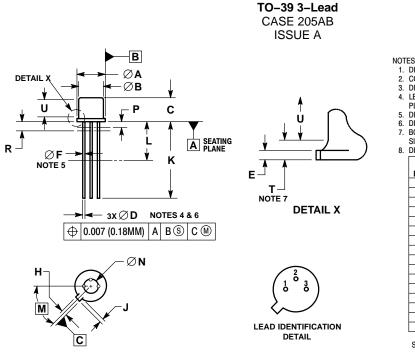
	MILLIMETERS		MILLIMETERS INCHES	
DIM	MIN	MAX	MIN	MAX
Α	8.89	9.40	0.350	0.370
В	8.00	8.51	0.315	0.335
C	6.10	6.60	0.240	0.260
D	0.41	0.53	0.016	0.021
E	0.23	3.18	0.009	0.125
F	0.41	0.48	0.016	0.019
Н	0.71	0.86	0.028	0.034
J	0.73	1.02	0.029	0.040
K	38.10	44.45	1.500	1.750
L	6.35		0.250	
Μ	45°BSC		45 °BSC	
N	5.08 BSC		0.200 BSC	
Ρ		1.27		0.050
R	1.37 BSC		0.054 BSC	
T		0.76		0.030
U	2.54		0.100	

STYLE 1: PIN 1. EMITTER BASE 2.

COLLECTOR 3.

2N3634, 2N3634L, 2N3635, 2N3635L, 2N3636, 2N3636L, 2N3637, 2N3637L

PACKAGE DIMENSIONS



DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: INCHES.

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	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.89	9.40	0.350	0.370
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E	0.23	3.18	0.009	0.125
F	0.41	0.48	0.016	0.019
Н	0.71	0.86	0.028	0.034
J	0.73	1.02	0.029	0.040
K	12.70	14.73	0.500	0.580
L	6.35		0.250	
М	45°BSC		45 °BSC	
Ν	5.08 BSC		0.200 BSC	
Ρ		1.27		0.050
R	1.37 BSC		0.054 BSC	
Т		0.76		0.030
U	2.54		0.100	

STYLE 1:

PIN 1. EMITTER BASE 2.

3. COLLECTOR

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